

Surface Mount RF Transformer

TC1.5-1

50Ω 0.5 to 2200 MHz

Maximum Ratings

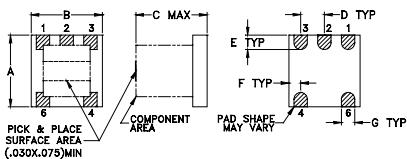
Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

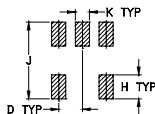
Pin Connections

PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	1
SECONDARY	4
NOT USED	2,3

Outline Drawing AT224



PCB Land Pattern



Suggested Layout:
Tolerance to be within ± 0.002

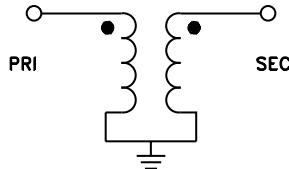
Outline Dimensions (inch mm)

A	B	C	D	E	F
.150	.150	.150	.050	.030	.025
3.81	3.81	3.81	1.27	0.76	0.64

G	H	J	K	wt
.028	.065	.190	.030	grams
0.71	1.65	4.83	0.76	0.10

Demo Board MCL P/N: TB-41

Config. D



Features

- wideband, 0.5-2200 MHz,
- excellent return loss
- terminations, solder plated with nickel barrier for solderability & excellent each resistance
- aqueous washable
- autotransformer



CASE STYLE: AT224

PRICE: Contact Sales Dept.

Applications

- impedance matching

Transformer Electrical Specifications

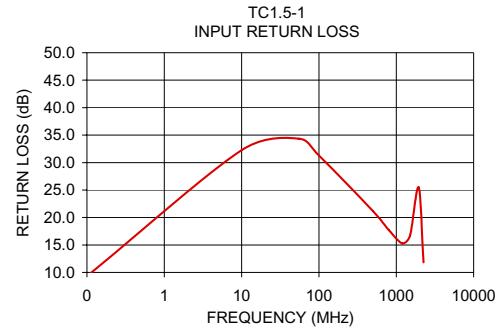
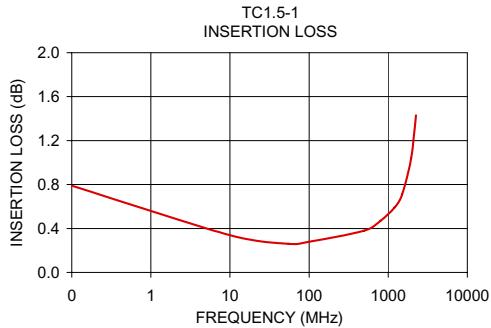
Ω RATIO (Secondary/Primary)	FREQUENCY (MHz)	INSERTION LOSS*		
		3 dB MHz	2 dB MHz	1 dB MHz
1.5	0.5-2200	0.5-2200	1-2000	2-1100

* Insertion Loss is referenced to mid-band loss, .3 dB typ.

NON-CATALOG

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)
0.10	0.79	9.30
10.00	0.34	32.27
55.00	0.26	34.33
100.00	0.28	31.27
500.00	0.38	21.15
800.00	0.47	17.71
1200.00	0.59	15.28
1500.00	0.71	16.70
1950.00	1.04	25.47
2250.00	1.43	11.82



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IF/RF MICROWAVE COMPONENTS

For detailed performance specs
& shopping online see web site



Provides ACTUAL Data Instantly at minicircuits.com

IF/RF MICROWAVE COMPONENTS

Notes: 1. Performance and quality attributes and conditions not expressly stated in this specification sheet are intended to be excluded and do not form a part of this specification sheet. 2. Electrical specifications and performance data contained herein are based on Mini-Circuit's applicable established test performance criteria and measurement instructions. 3. The parts covered by this specification sheet are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp.

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
0.10	0.79	9.30
0.19	0.43	14.64
0.37	0.37	20.31
0.55	0.37	23.44
0.73	0.37	25.46
1.00	0.35	27.48
2.02	0.44	25.35
6.01	0.40	30.91
10.00	0.34	32.27
55.00	0.26	34.33
70.00	0.25	33.04
100.00	0.28	31.27
500.00	0.38	21.15
800.00	0.47	17.71
1000.00	0.44	16.04
1100.00	0.51	15.47
1200.00	0.59	15.28
1500.00	0.71	16.70
1950.00	1.04	25.47
2100.00	1.11	25.62
2250.00	1.43	11.82



Typical Performance Curves

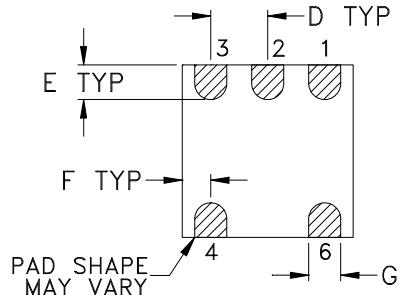
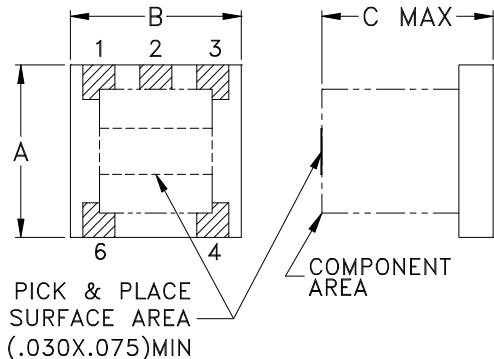


Case Style

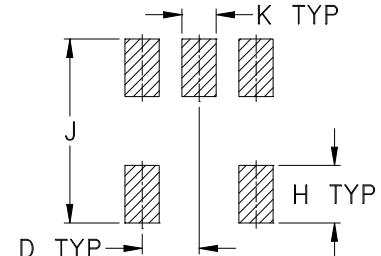
AT

Outline Dimensions

AT224



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	WT. GRAMS
AT224	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	--	.10

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

1. Open style, ceramic base.
2. Termination finish:
For RoHS Case Styles: 2-10 μ inch (.05-.25 microns) Gold over 100-300 μ inch (2.54-7.62 microns) Nickel plate.
All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



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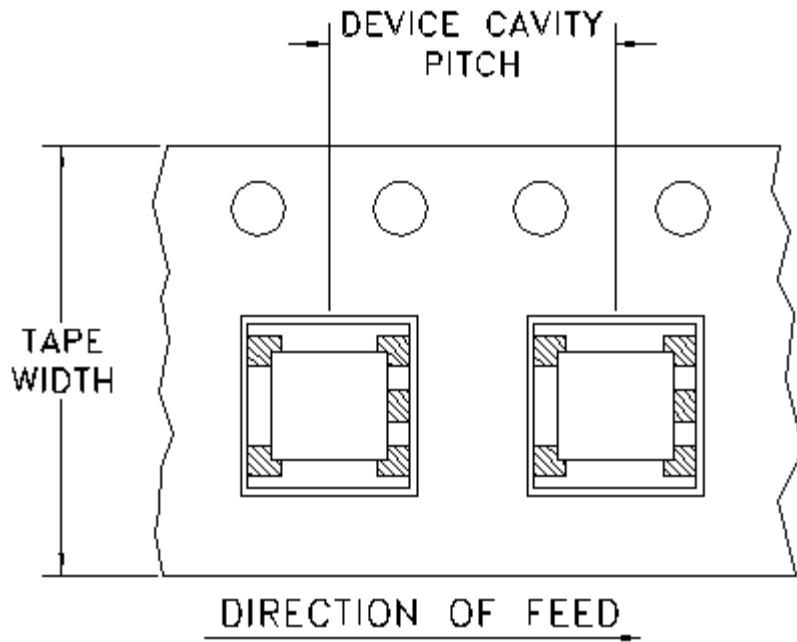


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RF/I/F MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
				2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



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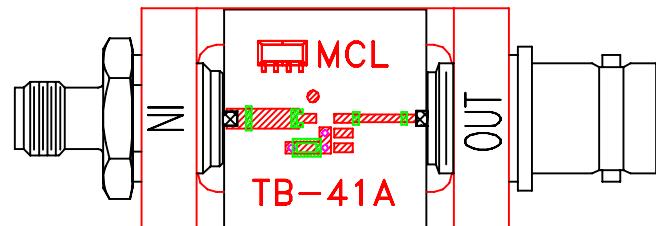
RF/IF MICROWAVE COMPONENTS

98-TR- Rev.: D (20 SEP 25) ECO-027008 File: 98-TR-F17 1

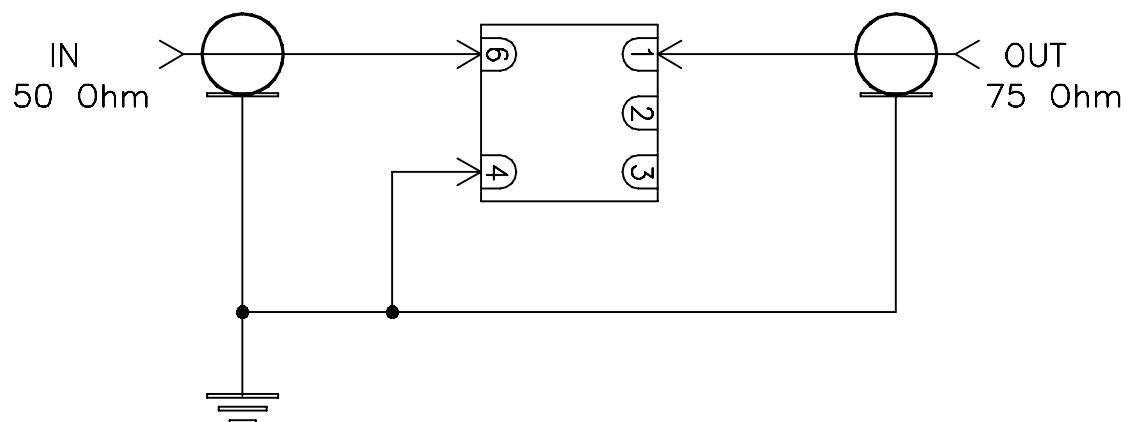
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Evaluation Board and Circuit



TB-41



Schematic Diagram

Notes:

1. 75 Ohm BNC and 50 Ohm SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.030 inch.

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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + propylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215